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Name of applicant, assignee or
Registered Representative



Signature

10/4/05

Date of Signature

Our Case No. 10322/57

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
Kuang Chien Hsieh et al.)
Serial No. 10/680,509) Examiner: Vikki Trinh
Filing Date: October 7, 2003) Group Art Unit No. 2811
For ADHESIVE BONDING WITH LOW)
TEMPERATURE GROWN)
AMORPHOUS OR)
POLYCRYSTALLINE COMPOUND)
SEMICONDUCTORS)

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action of May 11, 2005, please amend the application as follows:

Amendments to the Claims begin on page 2 of this paper.

Remarks are provided on page 9 of this paper.